# Renesas Electronics America Inc - R5F101LCAFB#50 Datasheet

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## What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

## Applications of "Embedded - Microcontrollers"

| Details | |
|---|---|
| Product Status | Active |
| Core Processor | RL78 |
| Core Size | 16-Bit |
| Speed | 32MHz |
| Connectivity | CSI, I²C, LINbus, UART/USART |
| Peripherals | DMA, LVD, POR, PWM, WDT |
| Number of I/O | 48 |
| Program Memory Size | 32KB (32K x 8) |
| Program Memory Type | FLASH |
| EEPROM Size | - |
| RAM Size | 2K x 8 |
| Voltage - Supply (Vcc/Vdd) | 1.6V ~ 5.5V |
| Data Converters | A/D 12x8/10b |
| Oscillator Type | Internal |
| Operating Temperature | -40°C ~ 85°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 64-LQFP |
| Supplier Device Package | 64-LFQFP (10x10) |
| Purchase URL | https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f101lcafb-50 |

**Table 1-1. List of Ordering Part Numbers**

(4/12)

| Pin count | Package | Data flash | Fields of Application Note | Ordering Part Number |
|---|---|---|---|---|
| 44 pins | 44-pin plastic LQFP (10 × 10 mm, 0.8 mm pitch) | Mounted | A | R5F100FAAFP#V0, R5F100FCAFP#V0, R5F100FDAFP#V0, R5F100FEAFP#V0, R5F100FFAFP#V0, R5F100FGAFP#V0, R5F100FHAFP#V0, R5F100FJAFP#V0, R5F100FKAFP#V0, R5F100FLAFP#V0<br>R5F100FAAFP#X0, R5F100FCAFP#X0, R5F100FDAFP#X0, R5F100FEAFP#X0, R5F100FFAFP#X0, R5F100FGAFP#X0, R5F100FHAFP#X0, R5F100FJAFP#X0, R5F100FKAFP#X0, R5F100FLAFP#X0 |
| | | | D | R5F100FADFP#V0, R5F100FCDFP#V0, R5F100FDDFP#V0, R5F100FEDFP#V0, R5F100FFDFP#V0, R5F100FGDFP#V0, R5F100FHDFP#V0, R5F100FJDFP#V0, R5F100FKDFP#V0, R5F100FLDFP#V0<br>R5F100FADFP#X0, R5F100FCDFP#X0, R5F100FDDFP#X0, R5F100FEDFP#X0, R5F100FFDFP#X0, R5F100FGDFP#X0, R5F100FHDFP#X0, R5F100FJDFP#X0, R5F100FKDFP#X0, R5F100FLDFP#X0 |
| | | | G | R5F100FAGFP#V0, R5F100FCGFP#V0, R5F100FDGFP#V0, R5F100FEGFP#V0, R5F100FFGFP#V0, R5F100FGGFP#V0, R5F100FHGFP#V0, R5F100FJGFP#V0<br>R5F100FAGFP#X0, R5F100FCGFP#X0, R5F100FDGFP#X0, R5F100FEGFP#X0, R5F100FFGFP#X0, R5F100FGGFP#X0, R5F100FHGFP#X0, R5F100FJGFP#X0 |
| | | Not mounted | A | R5F101FAAFP#V0, R5F101FCAFP#V0, R5F101FDAFP#V0, R5F101FEAFP#V0, R5F101FFAFP#V0, R5F101FGAFP#V0, R5F101FHAFP#V0, R5F101FJAFP#V0, R5F101FKAFP#V0, R5F101FLAFP#V0<br>R5F101FAAFP#X0, R5F101FCAFP#X0, R5F101FDAFP#X0, R5F101FEAFP#X0, R5F101FFAFP#X0, R5F101FGAFP#X0, R5F101FHAFP#X0, R5F101FJAFP#X0, R5F101FKAFP#X0, R5F101FLAFP#X0 |
| | | | D | R5F101FADFP#V0, R5F101FCDFP#V0, R5F101FDDFP#V0, R5F101FEDFP#V0, R5F101FFDFP#V0, R5F101FGDFP#V0, R5F101FHDFP#V0, R5F101FJDFP#V0, R5F101FKDFP#V0, R5F101FLDFP#V0<br>R5F101FADFP#X0, R5F101FCDFP#X0, R5F101FDDFP#X0, R5F101FEDFP#X0, R5F101FFDFP#X0, R5F101FGDFP#X0, R5F101FHDFP#X0, R5F101FJDFP#X0, R5F101FKDFP#X0, R5F101FLDFP#X0 |

**Note** For the fields of application, refer to **Figure 1-1 Part Number, Memory Size, and Package of RL78/G13**.

**Caution The ordering part numbers represent the numbers at the time of publication. For the latest ordering part numbers, refer to the target product page of the Renesas Electronics website.**

**Table 1-1. List of Ordering Part Numbers**

(5/12)

| Pin count | Package | Data flash | Fields of Application Note | Ordering Part Number |
|---|---|---|---|---|
| 48 pins | 48-pin plastic LFQFP (7 × 7 mm, 0.5 mm pitch) | Mounted | A | R5F100GAAFB#V0, R5F100GCAFB#V0, R5F100GDAFB#V0, R5F100GEAFB#V0, R5F100GFAFB#V0, R5F100GGAFB#V0, R5F100GHAFB#V0, R5F100GJAFB#V0, R5F100GKAFB#V0, R5F100GLAFB#V0<br>R5F100GAAFB#X0, R5F100GCAFB#X0, R5F100GDAFB#X0, R5F100GEAFB#X0, R5F100GFAFB#X0, R5F100GGAFB#X0, R5F100GHAFB#X0, R5F100GJAFB#X0, R5F100GKAFB#X0, R5F100GLAFB#X0 |
| | | | D | R5F100GADFB#V0, R5F100GCDFB#V0, R5F100GDDFB#V0, R5F100GEDFB#V0, R5F100GFDFB#V0, R5F100GGDFB#V0, R5F100GHDFB#V0, R5F100GJDFB#V0, R5F100GKDFB#V0, R5F100GLDFB#V0<br>R5F100GADFB#X0, R5F100GCDFB#X0, R5F100GDDFB#X0, R5F100GEDFB#X0, R5F100GFDFB#X0, R5F100GGDFB#X0, R5F100GHDFB#X0, R5F100GJDFB#X0, R5F100GKDFB#X0, R5F100GLDFB#X0 |
| | | | G | R5F100GAGFB#V0, R5F100GCGFB#V0, R5F100GDGFB#V0, R5F100GEGFB#V0, R5F100GFGFB#V0, R5F100GGGFB#V0, R5F100GHGFB#V0, R5F100GJGFB#V0<br>R5F100GAGFB#X0, R5F100GCGFB#X0, R5F100GDGFB#X0, R5F100GEGFB#X0, R5F100GFGFB#X0, R5F100GGGFB#X0, R5F100GHGFB#X0, R5F100GJGFB#X0 |
| | | Not mounted | A | R5F101GAAFB#V0, R5F101GCAFB#V0, R5F101GDAFB#V0, R5F101GEAFB#V0, R5F101GFAFB#V0, R5F101GGAFB#V0, R5F101GHAFB#V0, R5F101GJAFB#V0, R5F101GKAFB#V0, R5F101GLAFB#V0<br>R5F101GAAFB#X0, R5F101GCAFB#X0, R5F101GDAFB#X0, R5F101GEAFB#X0, R5F101GFAFB#X0, R5F101GGAFB#X0, R5F101GHAFB#X0, R5F101GJAFB#X0, R5F101GKAFB#X0, R5F101GLAFB#X0 |
| | | | D | R5F101GADFB#V0, R5F101GCDFB#V0, R5F101GDDFB#V0, R5F101GEDFB#V0, R5F101GFDFB#V0, R5F101GGDFB#V0, R5F101GHDFB#V0, R5F101GJDFB#V0, R5F101GKDFB#V0, R5F101GLDFB#V0<br>R5F101GADFB#X0, R5F101GCDFB#X0, R5F101GDDFB#X0, R5F101GEDFB#X0, R5F101GFDFB#X0, R5F101GGDFB#X0, R5F101GHDFB#X0, R5F101GJDFB#X0, R5F101GKDFB#X0, R5F101GLDFB#X0 |

**Note** For the fields of application, refer to **Figure 1-1 Part Number, Memory Size, and Package of RL78/G13**.

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**Table 1-1. List of Ordering Part Numbers**

(8/12)

| Pin count | Package | Data flash | Fields of Application [Note] | Ordering Part Number |
|---|---|---|---|---|
| 64 pins | 64-pin plastic LQFP (12 × 12 mm, 0.65 mm pitch) | Mounted | A | R5F100LCAFA#V0, R5F100LDAFA#V0, R5F100LEAFA#V0, R5F100LFAFA#V0, R5F100LGAFA#V0, R5F100LHAFA#V0, R5F100LJAFA#V0, R5F100LKAFA#V0, R5F100LLAFA#V0 R5F100LCAFA#X0, R5F100LDAFA#X0, R5F100LEAFA#X0, R5F100LFAFA#X0, |
| | | | D | R5F100LGAFA#X0, R5F100LHAFA#X0, R5F100LJAFA#X0, R5F100LKAFA#X0, R5F100LLAFA#X0 R5F100LCDFA#V0, R5F100LDDFA#V0, R5F100LEDFA#V0, R5F100LFDFA#V0, R5F100LGDFA#V0, R5F100LHDFA#V0, R5F100LJDFA#V0, R5F100LKDFA#V0, R5F100LLDFA#V0 |
| | | | G | R5F100LCDFA#X0, R5F100LDDFA#X0, R5F100LEDFA#X0, R5F100LFDFA#X0, R5F100LGDFA#X0, R5F100LHDFA#X0, R5F100LJDFA#X0, R5F100LKDFA#X0, R5F100LLDFA#X0 R5F100LCGFA#V0, R5F100LDGFA#V0, R5F100LEGFA#V0, R5F100LFGFA#V0 R5F100LCGFA#X0, R5F100LDGFA#X0, R5F100LEGFA#X0, R5F100LFGFA#X0 R5F100LGGFA#V0, R5F100LHGFA#V0, R5F100LJGFA#V0 R5F100LGGFA#X0, R5F100LHGFA#X0, R5F100LJGFA#X0 |
| | | Not mounted | A | R5F101LCAFA#V0, R5F101LDAFA#V0, R5F101LEAFA#V0, R5F101LFAFA#V0, R5F101LGAFA#V0, R5F101LHAFA#V0, R5F101LJAFA#V0, R5F101LKAFA#V0, R5F101LLAFA#V0 R5F101LCAFA#X0, R5F101LDAFA#X0, R5F101LEAFA#X0, R5F101LFAFA#X0, |
| | | | D | R5F101LGAFA#X0, R5F101LHAFA#X0, R5F101LJAFA#X0, R5F101LKAFA#X0, R5F101LLAFA#X0 R5F101LCDFA#V0, R5F101LDDFA#V0, R5F101LEDFA#V0, R5F101LFDFA#V0, R5F101LGDFA#V0, R5F101LHDFA#V0, R5F101LJDFA#V0, R5F101LKDFA#V0, R5F101LLDFA#V0 R5F101LCDFA#X0, R5F101LDDFA#X0, R5F101LEDFA#X0, R5F101LFDFA#X0, R5F101LGDFA#X0, R5F101LHDFA#X0, R5F101LJDFA#X0, R5F101LKDFA#X0, R5F101LLDFA#X0 |

**Note** For the fields of application, refer to **Figure 1-1 Part Number, Memory Size, and Package of RL78/G13**.

**Caution The ordering part numbers represent the numbers at the time of publication. For the latest ordering part numbers, refer to the target product page of the Renesas Electronics website.**

**Table 1-1. List of Ordering Part Numbers**

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| Pin count | Package | Data flash | Fields of Application Note | Ordering Part Number |
|---|---|---|---|---|
| 100 pins | 100-pin plastic LFQFP (14 × 14 mm, 0.5 mm pitch) | Mounted | A | R5F100PFAFB#V0, R5F100PGAFB#V0, R5F100PHAFB#V0, R5F100PJAFB#V0, R5F100PKAFB#V0, R5F100PLAFB#V0<br>R5F100PFAFB#X0, R5F100PGAFB#X0, R5F100PHAFB#X0, R5F100PJAFB#X0, R5F100PKAFB#X0, R5F100PLAFB#X0 |
| | | | D | R5F100PFDFB#V0, R5F100PGDFB#V0, R5F100PHDFB#V0, R5F100PJDFB#V0, R5F100PKDFB#V0, R5F100PLDFB#V0<br>R5F100PFDFB#X0, R5F100PGDFB#X0, R5F100PHDFB#X0, R5F100PJDFB#X0, R5F100PKDFB#X0, R5F100PLDFB#X0 |
| | | | G | R5F100PFGFB#V0, R5F100PGGFB#V0, R5F100PHGFB#V0, R5F100PJGFB#V0<br>R5F100PFGFB#X0, R5F100PGGFB#X0, R5F100PHGFB#X0, R5F100PJGFB#X0 |
| | | Not mounted | A | R5F101PFAFB#V0, R5F101PGAFB#V0, R5F101PHAFB#V0, R5F101PJAFB#V0, R5F101PKAFB#V0, R5F101PLAFB#V0<br>R5F101PFAFB#X0, R5F101PGAFB#X0, R5F101PHAFB#X0, R5F101PJAFB#X0, R5F101PKAFB#X0, R5F101PLAFB#X0 |
| | | | D | R5F101PFDFB#V0, R5F101PGDFB#V0, R5F101PHDFB#V0, R5F101PJDFB#V0, R5F101PKDFB#V0, R5F101PLDFB#V0<br>R5F101PFDFB#X0, R5F101PGDFB#X0, R5F101PHDFB#X0, R5F101PJDFB#X0, R5F101PKDFB#X0, R5F101PLDFB#X0 |
| | 100-pin plastic LQFP (14 × 20 mm, 0.65 mm pitch) | Mounted | A | R5F100PFAFA#V0, R5F100PGAFA#V0, R5F100PHAFA#V0, R5F100PJAFA#V0, R5F100PKAFA#V0, R5F100PLAFA#V0<br>R5F100PFAFA#X0, R5F100PGAFA#X0, R5F100PHAFA#X0, R5F100PJAFA#X0, R5F100PKAFA#X0, R5F100PLAFA#X0 |
| | | | D | R5F100PFDFA#V0, R5F100PGDFA#V0, R5F100PHDFA#V0, R5F100PJDFA#V0, R5F100PKDFA#V0, R5F100PLDFA#V0<br>R5F100PFDFA#X0, R5F100PGDFA#X0, R5F100PHDFA#X0, R5F100PJDFA#X0, R5F100PKDFA#X0, R5F100PLDFA#X0 |
| | | | G | R5F100PFGFA#V0, R5F100PGGFA#V0, R5F100PHGFA#V0, R5F100PJGFA#V0<br>R5F100PFGFA#X0, R5F100PGGFA#X0, R5F100PHGFA#X0, R5F100PJGFA#X0 |
| | | Not mounted | A | R5F101PFAFA#V0, R5F101PGAFA#V0, R5F101PHAFA#V0, R5F101PJAFA#V0, R5F101PKAFA#V0, R5F101PLAFA#V0<br>R5F101PFAFA#X0, R5F101PGAFA#X0, R5F101PHAFA#X0, R5F101PJAFA#X0, R5F101PKAFA#X0, R5F101PLAFA#X0 |
| | | | D | R5F101PFDFA#V0, R5F101PGDFA#V0, R5F101PHDFA#V0, R5F101PJDFA#V0, R5F101PKDFA#V0, R5F101PLDFA#V0<br>R5F101PFDFA#X0, R5F101PGDFA#X0, R5F101PHDFA#X0, R5F101PJDFA#X0, R5F101PKDFA#X0, R5F101PLDFA#X0 |

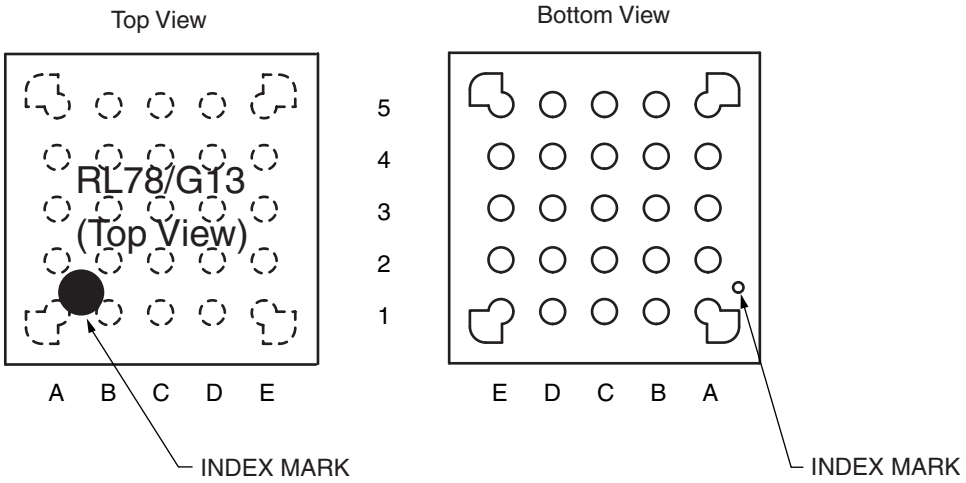
**Note** For the fields of application, refer to **Figure 1-1 Part Number, Memory Size, and Package of RL78/G13**.

**Caution The ordering part numbers represent the numbers at the time of publication. For the latest ordering part numbers, refer to the target product page of the Renesas Electronics website.**

### 1.3.3 25-pin products

- 25-pin plastic WFLGA (3 × 3 mm, 0.50 mm pitch)

<R>



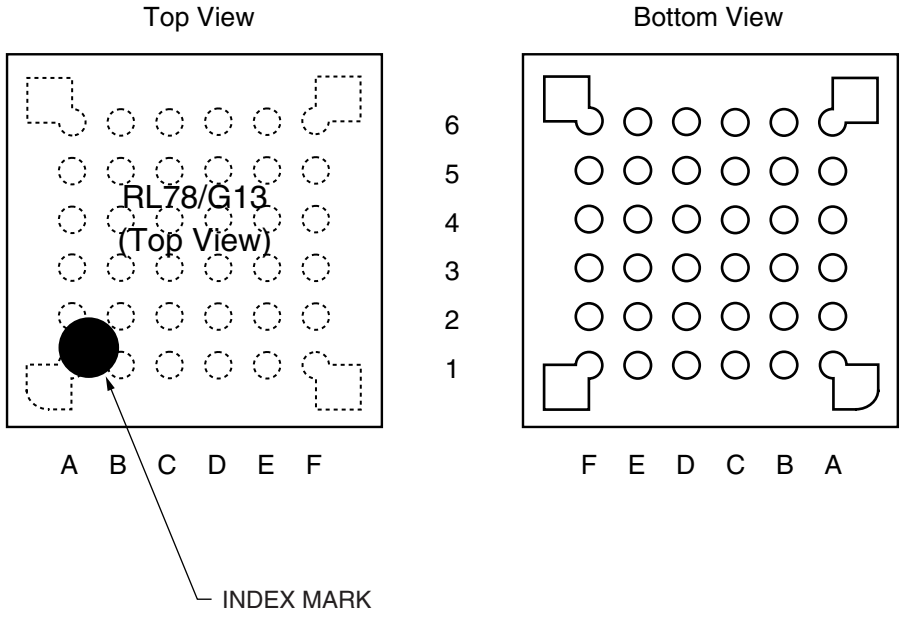

| | A | B | C | D | E | |
|---|---|---|---|---|---|---|
| 5 | P40/TOOL0 | $\overline{\text{RESET}}$ | P01/ANI16/ TO00/RxD1 | P22/ANI2 | P147/ANI18 | 5 |
| 4 | P122/X2/ EXCLK | P137/INTP0 | P00/ANI17/ TI00/TxD1 | P21/ANI1/ $AV_{REFM}$ | P10/SCK00/ SCL00 | 4 |
| 3 | P121/X1 | $V_{DD}$ | P20/ANI0/ $AV_{REFP}$ | P12/SO00/ TxD0/ TOOLTxD | P11/SI00/ RxD0/ TOOLRxD/ SDA00 | 3 |
| 2 | REGC | $V_{SS}$ | P30/INTP3/ SCK11/SCL11 | P17/TI02/ TO02/SO11 | P50/INTP1/ SI11/SDA11 | 2 |
| 1 | P60/SCLA0 | P61/SDAA0 | P31/TI03/ TO03/INTP4/ PCLBUZ0 | P16/TI01/ TO01/INTP5 | P130 | 1 |
| | A | B | C | D | E | |

**Caution Connect the REGC pin to Vss via a capacitor (0.47 to 1 μF).**

**Remark** For pin identification, see **1.4 Pin Identification**.

### 1.3.6 36-pin products

- 36-pin plastic WFLGA (4 × 4 mm, 0.5 mm pitch)




| | A | B | C | D | E | F | |
|---|---|---|---|---|---|---|---|
| 6 | P60/SCLA0 | $V_{DD}$ | P121/X1 | P122/X2/EXCLK | P137/INTP0 | P40/TOOL0 | 6 |
| 5 | P62 | P61/SDAA0 | $V_{SS}$ | REGC | $\overline{\text{RESET}}$ | P120/ANI19 | 5 |
| 4 | P72/SO21 | P71/SI21/ SDA21 | P14/RxD2/SI20/ SDA20/(SCLA0) /(TI03)/(TO03) | P31/TI03/TO03/ INTP4/ PCLBUZ0 | P00/TI00/TxD1 | P01/TO00/RxD1 | 4 |
| 3 | P50/INTP1/ SI11/SDA11 | P70/SCK21/ SCL21 | P15/PCLBUZ1/ SCK20/SCL20/ (TI02)/(TO02) | P22/ANI2 | P20/ANI0/ $AV_{REFP}$ | P21/ANI1/ $AV_{REFM}$ | 3 |
| 2 | P30/INTP3/ SCK11/SCL11 | P16/TI01/TO01/ INTP5/(RxD0) | P12/SO00/ TxD0/TOOLTxD /(TI05)/(TO05) | P11/SI00/RxD0/ TOOLRxD/ SDA00/(TI06)/ (TO06) | P24/ANI4 | P23/ANI3 | 2 |
| 1 | P51/INTP2/ SO11 | P17/TI02/TO02/ (TxD0) | P13/TxD2/ SO20/(SDAA0)/ (TI04)/(TO04) | P10/SCK00/ SCL00/(TI07)/ (TO07) | P147/ANI18 | P25/ANI5 | 1 |
| | A | B | C | D | E | F | |

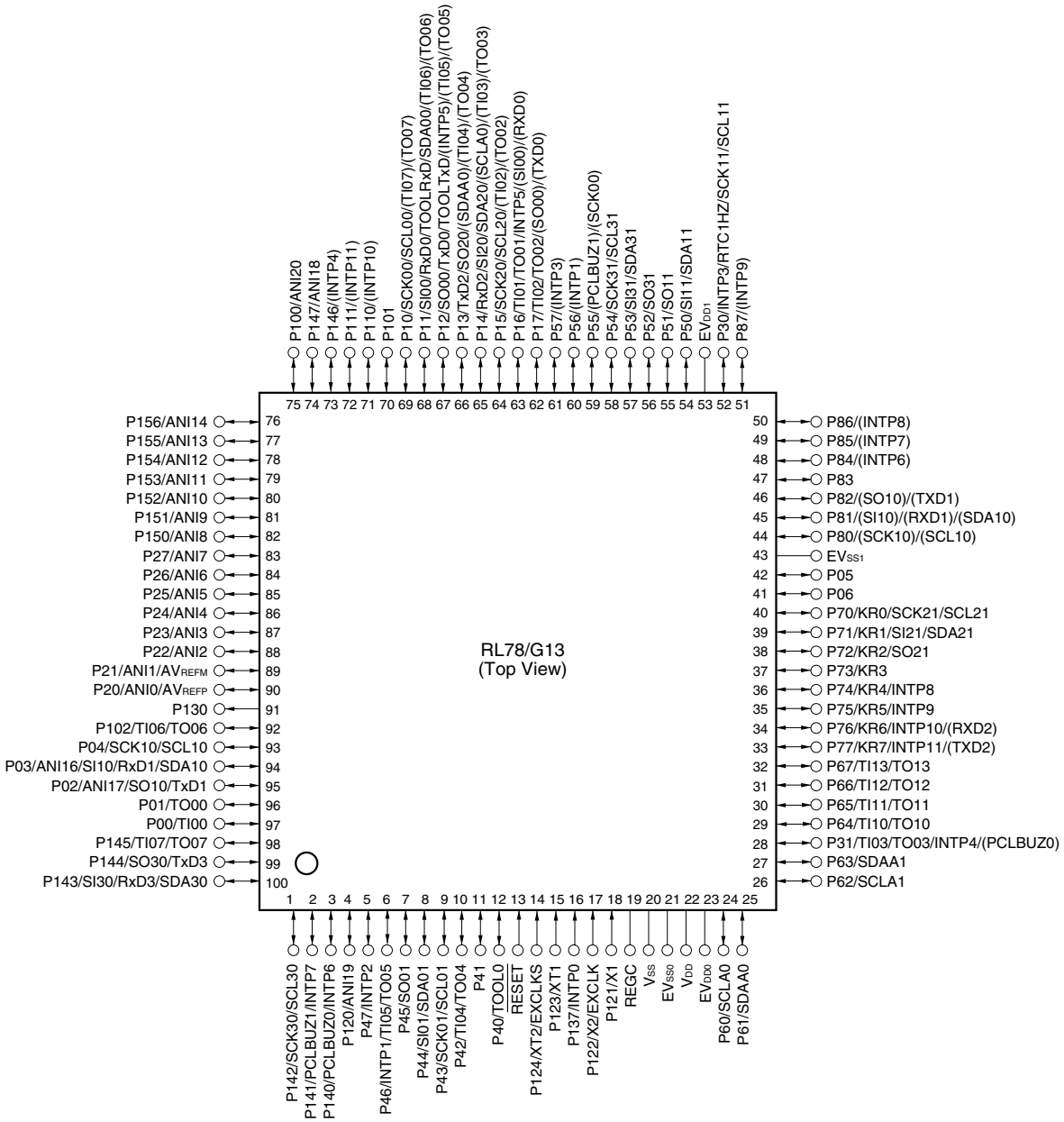
**Caution Connect the REGC pin to Vss via a capacitor (0.47 to 1 μF).**

**Remarks 1.** For pin identification, see **1.4 Pin Identification**.

**2.** Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.

### 1.3.13 100-pin products

- 100-pin plastic LQFP (14 × 14 mm, 0.5 mm pitch)




**Cautions 1. Make $EV_{SS0}$, $EV_{SS1}$ pins the same potential as $V_{SS}$ pin.**

**2. Make $V_{DD}$ pin the potential that is higher than $EV_{DD0}$, $EV_{DD1}$ pins ($EV_{DD0}$ = $EV_{DD1}$).**

**3. Connect the REGC pin to Vss via a capacitor (0.47 to 1 $\mu$F).**

**Remarks 1.** For pin identification, see **1.4 Pin Identification**.

**2.** When using the microcontroller for an application where the noise generated inside the microcontroller must be reduced, it is recommended to supply separate powers to the $V_{DD}$, $EV_{DD0}$ and $EV_{DD1}$ pins and connect the $V_{SS}$, $EV_{SS0}$ and $EV_{SS1}$ pins to separate ground lines.

**3.** Functions in parentheses in the above figure can be assigned via settings in the peripheral I/O redirection register (PIOR). Refer to **Figure 4-8 Format of Peripheral I/O Redirection Register (PIOR)** in the RL78/G13 User's Manual.

**2.** The number of PWM outputs varies depending on the setting of channels in use (the number of masters and slaves) (see **6.9.3 Operation as multiple PWM output function** in the RL78/G13 User's Manual).

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| Item | | 80-pin | | 100-pin | | 128-pin | |
|---|---|---|---|---|---|---|---|
| | | R5F100Mx | R5F101Mx | R5F100Px | R5F101Px | R5F100Sx | R5F101Sx |
| Clock output/buzzer output | | 2 | | 2 | | 2 | |
| | | • 2.44 kHz, 4.88 kHz, 9.76 kHz, 1.25 MHz, 2.5 MHz, 5 MHz, 10 MHz (Main system clock: $f_{MAIN}$ = 20 MHz operation)<br>• 256 Hz, 512 Hz, 1.024 kHz, 2.048 kHz, 4.096 kHz, 8.192 kHz, 16.384 kHz, 32.768 kHz (Subsystem clock: $f_{SUB}$ = 32.768 kHz operation) | | | | | |
| 8/10-bit resolution A/D converter | | 17 channels | | 20 channels | | 26 channels | |
| Serial interface | | [80-pin, 100-pin, 128-pin products]<br>• CSI: 2 channels/simplified $I^2C$: 2 channels/UART: 1 channel<br>• CSI: 2 channels/simplified $I^2C$: 2 channels/UART: 1 channel<br>• CSI: 2 channels/simplified $I^2C$: 2 channels/UART (UART supporting LIN-bus): 1 channel<br>• CSI: 2 channels/simplified $I^2C$: 2 channels/UART: 1 channel | | | | | |
| | $I^2C$ bus | 2 channels | | 2 channels | | 2 channels | |
| Multiplier and divider/multiply-accumulator | | • 16 bits × 16 bits = 32 bits (Unsigned or signed)<br>• 32 bits ÷ 32 bits = 32 bits (Unsigned)<br>• 16 bits × 16 bits + 32 bits = 32 bits (Unsigned or signed) | | | | | |
| DMA controller | | 4 channels | | | | | |
| Vectored interrupt sources | Internal | 37 | | 37 | | 41 | |
| | External | 13 | | 13 | | 13 | |
| Key interrupt | | 8 | | 8 | | 8 | |
| Reset | | • Reset by $\overline{\text{RESET}}$ pin<br>• Internal reset by watchdog timer<br>• Internal reset by power-on-reset<br>• Internal reset by voltage detector<br>• Internal reset by illegal instruction execution Note<br>• Internal reset by RAM parity error<br>• Internal reset by illegal-memory access | | | | | |
| Power-on-reset circuit | | • Power-on-reset: 1.51 V (TYP.)<br>• Power-down-reset: 1.50 V (TYP.) | | | | | |
| Voltage detector | | • Rising edge : 1.67 V to 4.06 V (14 stages)<br>• Falling edge : 1.63 V to 3.98 V (14 stages) | | | | | |
| On-chip debug function | | Provided | | | | | |
| Power supply voltage | | $V_{DD}$ = 1.6 to 5.5 V ($T_A$ = -40 to +85°C)<br>$V_{DD}$ = 2.4 to 5.5 V ($T_A$ = -40 to +105°C) | | | | | |
| <R> Operating ambient temperature | | $T_A$ = 40 to +85°C (A: Consumer applications, D: Industrial applications )<br>$T_A$ = 40 to +105°C (G: Industrial applications) | | | | | |

**Note** The illegal instruction is generated when instruction code FFH is executed.
Reset by the illegal instruction execution not issued by emulation with the in-circuit emulator or on-chip debug emulator.

**($T_A$ = –40 to +85°C, 1.6 V ≤ $EV_{DD0}$ = $EV_{DD1}$ ≤ $V_{DD}$ ≤ 5.5 V, $V_{SS}$ = $EV_{SS0}$ = $EV_{SS1}$ = 0 V) (2/5)**

| Items | Symbol | Conditions | | MIN. | TYP. | MAX. | Unit |
|---|---|---|---|---|---|---|---|
| Output current, low Note 1 | $I_{OL1}$ | Per pin for P00 to P07, P10 to P17, P30 to P37, P40 to P47, P50 to P57, P64 to P67, P70 to P77, P80 to P87, P90 to P97, P100 to P106, P110 to P117, P120, P125 to P127, P130, P140 to P147 | | | | 20.0 Note 2 | mA |
| | | Per pin for P60 to P63 | | | | 15.0 Note 2 | mA |
| | | Total of P00 to P04, P07, P32 to P37, P40 to P47, P102 to P106, P120, P125 to P127, P130, P140 to P145 (When duty ≤ 70% Note 3) | 4.0 V ≤ $EV_{DD0}$ ≤ 5.5 V | | | 70.0 | mA |
| | | | 2.7 V ≤ $EV_{DD0}$ < 4.0 V | | | 15.0 | mA |
| | | | 1.8 V ≤ $EV_{DD0}$ < 2.7 V | | | 9.0 | mA |
| | | | 1.6 V ≤ $EV_{DD0}$ < 1.8 V | | | 4.5 | mA |
| | | Total of P05, P06, P10 to P17, P30, P31, P50 to P57, P60 to P67, P70 to P77, P80 to P87, P90 to P97, P100, P101, P110 to P117, P146, P147 (When duty ≤ 70% Note 3) | 4.0 V ≤ $EV_{DD0}$ ≤ 5.5 V | | | 80.0 | mA |
| | | | 2.7 V ≤ $EV_{DD0}$ < 4.0 V | | | 35.0 | mA |
| | | | 1.8 V ≤ $EV_{DD0}$ < 2.7 V | | | 20.0 | mA |
| | | | 1.6 V ≤ $EV_{DD0}$ < 1.8 V | | | 10.0 | mA |
| | | Total of all pins (When duty ≤ 70% Note 3) | | | | 150.0 | mA |
| | $I_{OL2}$ | Per pin for P20 to P27, P150 to P156 | | | | 0.4 Note 2 | mA |
| | | Total of all pins (When duty ≤ 70% Note 3) | 1.6 V ≤ $V_{DD}$ ≤ 5.5 V | | | 5.0 | mA |

**Notes 1.** Value of current at which the device operation is guaranteed even if the current flows from an output pin to the $EV_{SS0}$, $EV_{SS1}$ and $V_{SS}$ pin.

**2.** However, do not exceed the total current value.

**3.** Specification under conditions where the duty factor ≤ 70%.
The output current value that has changed to the duty factor > 70% the duty ratio can be calculated with the following expression (when changing the duty factor from 70% to n%).

- Total output current of pins = ($I_{OL}$ × 0.7)/(n × 0.01)

<Example> Where n = 80% and $I_{OL}$ = 10.0 mA

Total output current of pins = (10.0 × 0.7)/(80 × 0.01) ≅ 8.7 mA

However, the current that is allowed to flow into one pin does not vary depending on the duty factor. A current higher than the absolute maximum rating must not flow into one pin.

**Remark** Unless specified otherwise, the characteristics of alternate-function pins are the same as those of the port pins.

### (2) Flash ROM: 96 to 256 KB of 30- to 100-pin products

**($T_A$ = −40 to +85°C, 1.6 V ≤ $EV_{DD0}$ = $EV_{DD1}$ ≤ $V_{DD}$ ≤ 5.5 V, $V_{SS}$ = $EV_{SS0}$ = $EV_{SS1}$ = 0 V) (1/2)**

| Parameter | Symbol | Conditions | | | | | MIN. | TYP. | MAX. | Unit |
|---|---|---|---|---|---|---|---|---|---|---|
| Supply current Note 1 | $I_{DD1}$ | Operating mode | HS (high-speed main) mode Note 5 | $f_{IH}$ = 32 MHz Note 3 | Basic operation | $V_{DD}$ = 5.0 V | | 2.3 | | mA |
| | | | | | | $V_{DD}$ = 3.0 V | | 2.3 | | mA |
| | | | | | Normal operation | $V_{DD}$ = 5.0 V | | 5.2 | 8.5 | mA |
| | | | | | | $V_{DD}$ = 3.0 V | | 5.2 | 8.5 | mA |
| | | | | $f_{IH}$ = 24 MHz Note 3 | Normal operation | $V_{DD}$ = 5.0 V | | 4.1 | 6.6 | mA |
| | | | | | | $V_{DD}$ = 3.0 V | | 4.1 | 6.6 | mA |
| | | | | $f_{IH}$ = 16 MHz Note 3 | Normal operation | $V_{DD}$ = 5.0 V | | 3.0 | 4.7 | mA |
| | | | | | | $V_{DD}$ = 3.0 V | | 3.0 | 4.7 | mA |
| | | | LS (low-speed main) mode Note 5 | $f_{IH}$ = 8 MHz Note 3 | Normal operation | $V_{DD}$ = 3.0 V | | 1.3 | 2.1 | mA |
| | | | | | | $V_{DD}$ = 2.0 V | | 1.3 | 2.1 | mA |
| | | | LV (low-voltage main) mode Note 5 | $f_{IH}$ = 4 MHz Note 3 | Normal operation | $V_{DD}$ = 3.0 V | | 1.3 | 1.8 | mA |
| | | | | | | $V_{DD}$ = 2.0 V | | 1.3 | 1.8 | mA |
| | | | HS (high-speed main) mode Note 5 | $f_{MX}$ = 20 MHz Note 2, $V_{DD}$ = 5.0 V | Normal operation | Square wave input | | 3.4 | 5.5 | mA |
| | | | | | | Resonator connection | | 3.6 | 5.7 | mA |
| | | | | $f_{MX}$ = 20 MHz Note 2, $V_{DD}$ = 3.0 V | Normal operation | Square wave input | | 3.4 | 5.5 | mA |
| | | | | | | Resonator connection | | 3.6 | 5.7 | mA |
| | | | | $f_{MX}$ = 10 MHz Note 2, $V_{DD}$ = 5.0 V | Normal operation | Square wave input | | 2.1 | 3.2 | mA |
| | | | | | | Resonator connection | | 2.1 | 3.2 | mA |
| | | | | $f_{MX}$ = 10 MHz Note 2, $V_{DD}$ = 3.0 V | Normal operation | Square wave input | | 2.1 | 3.2 | mA |
| | | | | | | Resonator connection | | 2.1 | 3.2 | mA |
| | | | LS (low-speed main) mode Note 5 | $f_{MX}$ = 8 MHz Note 2, $V_{DD}$ = 3.0 V | Normal operation | Square wave input | | 1.2 | 2.0 | mA |
| | | | | | | Resonator connection | | 1.2 | 2.0 | mA |
| | | | | $f_{MX}$ = 8 MHz Note 2, $V_{DD}$ = 2.0 V | Normal operation | Square wave input | | 1.2 | 2.0 | mA |
| | | | | | | Resonator connection | | 1.2 | 2.0 | mA |
| | | | Subsystem clock operation | $f_{SUB}$ = 32.768 kHz Note 4 $T_A$ = −40°C | Normal operation | Square wave input | | 4.8 | 5.9 | μA |
| | | | | | | Resonator connection | | 4.9 | 6.0 | μA |
| | | | | $f_{SUB}$ = 32.768 kHz Note 4 $T_A$ = +25°C | Normal operation | Square wave input | | 4.9 | 5.9 | μA |
| | | | | | | Resonator connection | | 5.0 | 6.0 | μA |
| | | | | $f_{SUB}$ = 32.768 kHz Note 4 $T_A$ = +50°C | Normal operation | Square wave input | | 5.0 | 7.6 | μA |
| | | | | | | Resonator connection | | 5.1 | 7.7 | μA |
| | | | | $f_{SUB}$ = 32.768 kHz Note 4 $T_A$ = +70°C | Normal operation | Square wave input | | 5.2 | 9.3 | μA |
| | | | | | | Resonator connection | | 5.3 | 9.4 | μA |
| | | | | $f_{SUB}$ = 32.768 kHz Note 4 $T_A$ = +85°C | Normal operation | Square wave input | | 5.7 | 13.3 | μA |
| | | | | | | Resonator connection | | 5.8 | 13.4 | μA |

(**Notes** and **Remarks** are listed on the next page.)

**6.** Current flowing only to the A/D converter. The supply current of the RL78 microcontrollers is the sum of $I_{DD1}$ or $I_{DD2}$ and $I_{ADC}$ when the A/D converter operates in an operation mode or the HALT mode.

**7.** Current flowing only to the LVD circuit. The supply current of the RL78 microcontrollers is the sum of $I_{DD1}$, $I_{DD2}$ or $I_{DD3}$ and $I_{LVD}$ when the LVD circuit is in operation.

**8.** Current flowing only during data flash rewrite.

**9.** Current flowing only during self programming.

**10.** For shift time to the SNOOZE mode, see **18.3.3 SNOOZE mode.**

**Remarks 1.** $f_{IL}$: Low-speed on-chip oscillator clock frequency

**2.** $f_{SUB}$: Subsystem clock frequency (XT1 clock oscillation frequency)

**3.** $f_{CLK}$: CPU/peripheral hardware clock frequency

**4.** Temperature condition of the TYP. value is $T_A$ = 25°C

**(2) During communication at same potential (CSI mode) (master mode, SCKp... internal clock output, corresponding CSI00 only)**

**($T_A$ = –40 to +85°C, 2.7 V ≤ $EV_{DD0}$ = $EV_{DD1}$ ≤ $V_{DD}$ ≤ 5.5 V, $V_{SS}$ = $EV_{SS0}$ = $EV_{SS1}$ = 0 V)**

| Parameter | Symbol | Conditions | | HS (high-speed main) Mode | | LS (low-speed main) Mode | | LV (low-voltage main) Mode | | Unit |
|---|---|---|---|---|---|---|---|---|---|---|
| | | | | MIN. | MAX. | MIN. | MAX. | MIN. | MAX. | |
| SCKp cycle time | $t_{KCY1}$ | $t_{KCY1} \geq 2/f_{CLK}$ | 4.0 V ≤ $EV_{DD0}$ ≤ 5.5 V | 62.5 | | 250 | | 500 | | ns |
| | | | 2.7 V ≤ $EV_{DD0}$ ≤ 5.5 V | 83.3 | | 250 | | 500 | | ns |
| SCKp high-/low-level width | $t_{KH1}$, $t_{KL1}$ | 4.0 V ≤ $EV_{DD0}$ ≤ 5.5 V | | $t_{KCY1}/2$ – 7 | | $t_{KCY1}/2$ – 50 | | $t_{KCY1}/2$ – 50 | | ns |
| | | 2.7 V ≤ $EV_{DD0}$ ≤ 5.5 V | | $t_{KCY1}/2$ – 10 | | $t_{KCY1}/2$ – 50 | | $t_{KCY1}/2$ – 50 | | ns |
| SIp setup time (to SCKp↑) Note 1 | $t_{SIK1}$ | 4.0 V ≤ $EV_{DD0}$ ≤ 5.5 V | | 23 | | 110 | | 110 | | ns |
| | | 2.7 V ≤ $EV_{DD0}$ ≤ 5.5 V | | 33 | | 110 | | 110 | | ns |
| SIp hold time (from SCKp↑) Note 2 | $t_{KSI1}$ | 2.7 V ≤ $EV_{DD0}$ ≤ 5.5 V | | 10 | | 10 | | 10 | | ns |
| Delay time from SCKp↓ to SOp output Note 3 | $t_{KSO1}$ | C = 20 pF Note 4 | | | 10 | | 10 | | 10 | ns |

**Notes 1.** When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The SIp setup time becomes "to SCKp↓" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

**2.** When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The SIp hold time becomes "from SCKp↓" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

**3.** When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The delay time to SOp output becomes "from SCKp↑" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

**4.** C is the load capacitance of the SCKp and SOp output lines.

**Caution Select the normal input buffer for the SIp pin and the normal output mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg).**

**Remarks 1.** This value is valid only when CSI00's peripheral I/O redirect function is not used.

**2.** p: CSI number (p = 00), m: Unit number (m = 0), n: Channel number (n = 0),
g: PIM and POM numbers (g = 1)

**3.** $f_{MCK}$: Serial array unit operation clock frequency
(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn). m: Unit number, n: Channel number (mn = 00))

**(3) During communication at same potential (CSI mode) (master mode, SCKp... internal clock output)**

**($T_A$ = –40 to +85°C, 1.6 V ≤ $EV_{DD0}$ = $EV_{DD1}$ ≤ $V_{DD}$ ≤ 5.5 V, $V_{SS}$ = $EV_{SS0}$ = $EV_{SS1}$ = 0 V)**

| Parameter | Symbol | Conditions | | HS (high-speed main) Mode | | LS (low-speed main) Mode | | LV (low-voltage main) Mode | | Unit |
|---|---|---|---|---|---|---|---|---|---|---|
| | | | | MIN. | MAX. | MIN. | MAX. | MIN. | MAX. | |
| SCKp cycle time | $t_{KCY1}$ | $t_{KCY1} \geq 4/f_{CLK}$ | 2.7 V ≤ $EV_{DD0}$ ≤ 5.5 V | 125 | | 500 | | 1000 | | ns |
| | | | 2.4 V ≤ $EV_{DD0}$ ≤ 5.5 V | 250 | | 500 | | 1000 | | ns |
| | | | 1.8 V ≤ $EV_{DD0}$ ≤ 5.5 V | 500 | | 500 | | 1000 | | ns |
| | | | 1.7 V ≤ $EV_{DD0}$ ≤ 5.5 V | 1000 | | 1000 | | 1000 | | ns |
| | | | 1.6 V ≤ $EV_{DD0}$ ≤ 5.5 V | — | | 1000 | | 1000 | | ns |
| SCKp high-/low-level width | $t_{KH1}$, $t_{KL1}$ | 4.0 V ≤ $EV_{DD0}$ ≤ 5.5 V | | $t_{KCY1}$/2 – 12 | | $t_{KCY1}$/2 – 50 | | $t_{KCY1}$/2 – 50 | | ns |
| | | 2.7 V ≤ $EV_{DD0}$ ≤ 5.5 V | | $t_{KCY1}$/2 – 18 | | $t_{KCY1}$/2 – 50 | | $t_{KCY1}$/2 – 50 | | ns |
| | | 2.4 V ≤ $EV_{DD0}$ ≤ 5.5 V | | $t_{KCY1}$/2 – 38 | | $t_{KCY1}$/2 – 50 | | $t_{KCY1}$/2 – 50 | | ns |
| | | 1.8 V ≤ $EV_{DD0}$ ≤ 5.5 V | | $t_{KCY1}$/2 – 50 | | $t_{KCY1}$/2 – 50 | | $t_{KCY1}$/2 – 50 | | ns |
| | | 1.7 V ≤ $EV_{DD0}$ ≤ 5.5 V | | $t_{KCY1}$/2 – 100 | | $t_{KCY1}$/2 – 100 | | $t_{KCY1}$/2 – 100 | | ns |
| | | 1.6 V ≤ $EV_{DD0}$ ≤ 5.5 V | | — | | $t_{KCY1}$/2 – 100 | | $t_{KCY1}$/2 – 100 | | ns |
| SIp setup time (to SCKp↑) Note 1 | $t_{SIK1}$ | 4.0 V ≤ $EV_{DD0}$ ≤ 5.5 V | | 44 | | 110 | | 110 | | ns |
| | | 2.7 V ≤ $EV_{DD0}$ ≤ 5.5 V | | 44 | | 110 | | 110 | | ns |
| | | 2.4 V ≤ $EV_{DD0}$ ≤ 5.5 V | | 75 | | 110 | | 110 | | ns |
| | | 1.8 V ≤ $EV_{DD0}$ ≤ 5.5 V | | 110 | | 110 | | 110 | | ns |
| | | 1.7 V ≤ $EV_{DD0}$ ≤ 5.5 V | | 220 | | 220 | | 220 | | ns |
| | | 1.6 V ≤ $EV_{DD0}$ ≤ 5.5 V | | — | | 220 | | 220 | | ns |
| SIp hold time (from SCKp↑) Note 2 | $t_{KSI1}$ | 1.7 V ≤ $EV_{DD0}$ ≤ 5.5 V | | 19 | | 19 | | 19 | | ns |
| | | 1.6 V ≤ $EV_{DD0}$ ≤ 5.5 V | | — | | 19 | | 19 | | ns |
| Delay time from SCKp↓ to SOp output Note 3 | $t_{KSO1}$ | 1.7 V ≤ $EV_{DD0}$ ≤ 5.5 V C = 30 pF Note 4 | | | 25 | | 25 | | 25 | ns |
| | | 1.6 V ≤ $EV_{DD0}$ ≤ 5.5 V C = 30 pF Note 4 | | | — | | 25 | | 25 | ns |

**Notes 1.** When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The SIp setup time becomes "to SCKp↓" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

**2.** When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The SIp hold time becomes "from SCKp↓" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

**3.** When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The delay time to SOp output becomes "from SCKp↑" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

**4.** C is the load capacitance of the SCKp and SOp output lines.

**Caution Select the normal input buffer for the SIp pin and the normal output mode for the SOp pin and SCKp pin by using port input mode register g (PIMg) and port output mode register g (POMg).**

**Notes 1.** The first clock pulse is generated after this period when the start/restart condition is detected.

<R> **2.** The maximum value (MAX.) of $t_{HD:DAT}$ is during normal transfer and a wait state is inserted in the ACK (acknowledge) timing.

**Caution The values in the above table are applied even when bit 2 (PIOR2) in the peripheral I/O redirection register (PIOR) is 1. At this time, the pin characteristics ($I_{OH1}$, $I_{OL1}$, $V_{OH1}$, $V_{OL1}$) must satisfy the values in the redirect destination.**

**Remark** The maximum value of Cb (communication line capacitance) and the value of Rb (communication line pull-up resistor) at that time in each mode are as follows.

Standard mode: $C_b$ = 400 pF, $R_b$ = 2.7 kΩ

**(1) Flash ROM: 16 to 64 KB of 20- to 64-pin products**

**($T_A$ = –40 to +105°C, 2.4 V ≤ $EV_{DD0}$ ≤ $V_{DD}$ ≤ 5.5 V, $V_{SS}$ = $EV_{SS0}$ = 0 V) (2/2)**

| Parameter | Symbol | Conditions | | | | MIN. | TYP. | MAX. | Unit |
|---|---|---|---|---|---|---|---|---|---|
| Supply current Note 1 | $I_{DD2}$ Note 2 | HALT mode | HS (high-speed main) mode Note 7 | $f_{IH}$ = 32 MHz Note 4 | $V_{DD}$ = 5.0 V | | 0.54 | 2.90 | mA |
| | | | | | $V_{DD}$ = 3.0 V | | 0.54 | 2.90 | mA |
| | | | | $f_{IH}$ = 24 MHz Note 4 | $V_{DD}$ = 5.0 V | | 0.44 | 2.30 | mA |
| | | | | | $V_{DD}$ = 3.0 V | | 0.44 | 2.30 | mA |
| | | | | $f_{IH}$ = 16 MHz Note 4 | $V_{DD}$ = 5.0 V | | 0.40 | 1.70 | mA |
| | | | | | $V_{DD}$ = 3.0 V | | 0.40 | 1.70 | mA |
| | | | HS (high-speed main) mode Note 7 | $f_{MX}$ = 20 MHz Note 3, $V_{DD}$ = 5.0 V | Square wave input | | 0.28 | 1.90 | mA |
| | | | | | Resonator connection | | 0.45 | 2.00 | mA |
| | | | | $f_{MX}$ = 20 MHz Note 3, $V_{DD}$ = 3.0 V | Square wave input | | 0.28 | 1.90 | mA |
| | | | | | Resonator connection | | 0.45 | 2.00 | mA |
| | | | | $f_{MX}$ = 10 MHz Note 3, $V_{DD}$ = 5.0 V | Square wave input | | 0.19 | 1.02 | mA |
| | | | | | Resonator connection | | 0.26 | 1.10 | mA |
| | | | | $f_{MX}$ = 10 MHz Note 3, $V_{DD}$ = 3.0 V | Square wave input | | 0.19 | 1.02 | mA |
| | | | | | Resonator connection | | 0.26 | 1.10 | mA |
| | | | Subsystem clock operation | $f_{SUB}$ = 32.768 kHz Note 5 $T_A$ = –40°C | Square wave input | | 0.25 | 0.57 | μA |
| | | | | | Resonator connection | | 0.44 | 0.76 | μA |
| | | | | $f_{SUB}$ = 32.768 kHz Note 5 $T_A$ = +25°C | Square wave input | | 0.30 | 0.57 | μA |
| | | | | | Resonator connection | | 0.49 | 0.76 | μA |
| | | | | $f_{SUB}$ = 32.768 kHz Note 5 $T_A$ = +50°C | Square wave input | | 0.37 | 1.17 | μA |
| | | | | | Resonator connection | | 0.56 | 1.36 | μA |
| | | | | $f_{SUB}$ = 32.768 kHz Note 5 $T_A$ = +70°C | Square wave input | | 0.53 | 1.97 | μA |
| | | | | | Resonator connection | | 0.72 | 2.16 | μA |
| | | | | $f_{SUB}$ = 32.768 kHz Note 5 $T_A$ = +85°C | Square wave input | | 0.82 | 3.37 | μA |
| | | | | | Resonator connection | | 1.01 | 3.56 | μA |
| | | | | $f_{SUB}$ = 32.768 kHz Note 5 $T_A$ = +105°C | Square wave input | | 3.01 | 15.37 | μA |
| | | | | | Resonator connection | | 3.20 | 15.56 | μA |
| | $I_{DD3}$ Note 6 | STOP mode Note 8 | $T_A$ = –40°C | | | | 0.18 | 0.50 | μA |
| | | | $T_A$ = +25°C | | | | 0.23 | 0.50 | μA |
| | | | $T_A$ = +50°C | | | | 0.30 | 1.10 | μA |
| | | | $T_A$ = +70°C | | | | 0.46 | 1.90 | μA |
| | | | $T_A$ = +85°C | | | | 0.75 | 3.30 | μA |
| | | | $T_A$ = +105°C | | | | 2.94 | 15.30 | μA |

(**Notes** and **Remarks** are listed on the next page.)

**Notes 1.** Total current flowing into $V_{DD}$, $EV_{DD0}$, and $EV_{DD1}$, including the input leakage current flowing when the level of the input pin is fixed to $V_{DD}$, $EV_{DD0}$, and $EV_{DD1}$, or $V_{SS}$, $EV_{SS0}$, and $EV_{SS1}$. The values below the MAX. column include the peripheral operation current. However, not including the current flowing into the A/D converter, LVD circuit, I/O port, and on-chip pull-up/pull-down resistors and the current flowing during data flash rewrite.

**2.** When high-speed on-chip oscillator and subsystem clock are stopped.

**3.** When high-speed system clock and subsystem clock are stopped.

**4.** When high-speed on-chip oscillator and high-speed system clock are stopped. When AMPHS1 = 1 (Ultra-low power consumption oscillation). However, not including the current flowing into the 12-bit interval timer and watchdog timer.

**5.** Relationship between operation voltage width, operation frequency of CPU and operation mode is as below.

HS (high-speed main) mode: 2.7 V ≤ $V_{DD}$ ≤ 5.5 V@1 MHz to 32 MHz
2.4 V ≤ $V_{DD}$ ≤ 5.5 V@1 MHz to 16 MHz

**Remarks 1.** $f_{MX}$: High-speed system clock frequency (X1 clock oscillation frequency or external main system clock frequency)

**2.** $f_{IH}$: High-speed on-chip oscillator clock frequency

**3.** $f_{SUB}$: Subsystem clock frequency (XT1 clock oscillation frequency)

**4.** Except subsystem clock operation, temperature condition of the TYP. value is $T_A$ = 25°C

**Notes 1.** Transfer rate in the SNOOZE mode : MAX. 1 Mbps

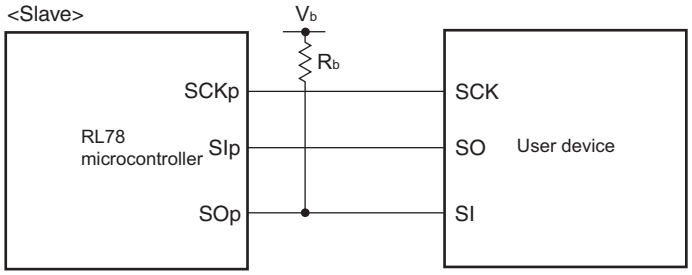
**2.** When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The SIp setup time becomes "to SCKp↓" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

**3.** When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The SIp hold time becomes "from SCKp↓" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

**4.** When DAPmn = 0 and CKPmn = 0, or DAPmn = 1 and CKPmn = 1. The delay time to SOp output becomes "from SCKp↑" when DAPmn = 0 and CKPmn = 1, or DAPmn = 1 and CKPmn = 0.

**Caution Select the TTL input buffer for the SIp pin and SCKp pin and the N-ch open drain output ($V_{DD}$ tolerance (for the 20- to 52-pin products)/$EV_{DD}$ tolerance (for the 64- to 128-pin products)) mode for the SOp pin by using port input mode register g (PIMg) and port output mode register g (POMg). For $V_{IH}$ and $V_{IL}$, see the DC characteristics with TTL input buffer selected.**

**CSI mode connection diagram (during communication at different potential)**




**Remarks 1.** $R_b$[Ω]:Communication line (SOp) pull-up resistance, $C_b$[F]: Communication line (SOp) load capacitance, $V_b$[V]: Communication line voltage

**2.** p: CSI number (p = 00, 01, 10, 20, 30, 31), m: Unit number (m = 0, 1), n: Channel number (n = 00, 01, 02,
10, 12, 13), g: PIM and POM number (g = 0, 1, 4, 5, 8, 14)

**3.** $f_{MCK}$: Serial array unit operation clock frequency
(Operation clock to be set by the CKSmn bit of serial mode register mn (SMRmn).
m: Unit number, n: Channel number (mn = 00, 01, 02, 10, 12, 13))

**4.** CSI01 of 48-, 52-, 64-pin products, and CSI11 and CSI21 cannot communicate at different potential. Use other CSI for communication at different potential.

**(8) Communication at different potential (1.8 V, 2.5 V, 3 V) (simplified $I^2C$ mode) (2/2)**

**($T_A$ = –40 to +105°C, 2.4 V ≤ $EV_{DD0}$ = $EV_{DD1}$ ≤ $V_{DD}$ ≤ 5.5 V, $V_{SS}$ = $EV_{SS0}$ = $EV_{SS1}$ = 0 V)**

| Parameter | Symbol | Conditions | HS (high-speed main) Mode | | Unit |
|---|---|---|---|---|---|
| | | | MIN. | MAX. | |
| Data setup time (reception) | $t_{SU:DAT}$ | 4.0 V ≤ $EV_{DD0}$ ≤ 5.5 V, 2.7 V ≤ $V_b$ ≤ 4.0 V, $C_b$ = 50 pF, $R_b$ = 2.7 kΩ | 1/$f_{MCK}$ + 340 Note 2 | | ns |
| | | 2.7 V ≤ $EV_{DD0}$ < 4.0 V, 2.3 V ≤ $V_b$ ≤ 2.7 V, $C_b$ = 50 pF, $R_b$ = 2.7 kΩ | 1/$f_{MCK}$ + 340 Note 2 | | ns |
| | | 4.0 V ≤ $EV_{DD0}$ ≤ 5.5 V, 2.7 V ≤ $V_b$ ≤ 4.0 V, $C_b$ = 100 pF, $R_b$ = 2.8 kΩ | 1/$f_{MCK}$ + 760 Note 2 | | ns |
| | | 2.7 V ≤ $EV_{DD0}$ < 4.0 V, 2.3 V ≤ $V_b$ ≤ 2.7 V, $C_b$ = 100 pF, $R_b$ = 2.7 kΩ | 1/$f_{MCK}$ + 760 Note 2 | | ns |
| | | 2.4 V ≤ $EV_{DD0}$ < 3.3 V, 1.6 V ≤ $V_b$ ≤ 2.0 V, $C_b$ = 100 pF, $R_b$ = 5.5 kΩ | 1/$f_{MCK}$ + 570 Note 2 | | ns |
| Data hold time (transmission) | $t_{HD:DAT}$ | 4.0 V ≤ $EV_{DD0}$ ≤ 5.5 V, 2.7 V ≤ $V_b$ ≤ 4.0 V, $C_b$ = 50 pF, $R_b$ = 2.7 kΩ | 0 | 770 | ns |
| | | 2.7 V ≤ $EV_{DD0}$ < 4.0 V, 2.3 V ≤ $V_b$ ≤ 2.7 V, $C_b$ = 50 pF, $R_b$ = 2.7 kΩ | 0 | 770 | ns |
| | | 4.0 V ≤ $EV_{DD0}$ ≤ 5.5 V, 2.7 V ≤ $V_b$ ≤ 4.0 V, $C_b$ = 100 pF, $R_b$ = 2.8 kΩ | 0 | 1420 | ns |
| | | 2.7 V ≤ $EV_{DD0}$ < 4.0 V, 2.3 V ≤ $V_b$ ≤ 2.7 V, $C_b$ = 100 pF, $R_b$ = 2.7 kΩ | 0 | 1420 | ns |
| | | 2.4 V ≤ $EV_{DD0}$ < 3.3 V, 1.6 V ≤ $V_b$ ≤ 2.0 V, $C_b$ = 100 pF, $R_b$ = 5.5 kΩ | 0 | 1215 | ns |

**Notes 1.** The value must also be equal to or less than $f_{MCK}$/4.

**2.** Set the $f_{MCK}$ value to keep the hold time of SCLr = "L" and SCLr = "H".

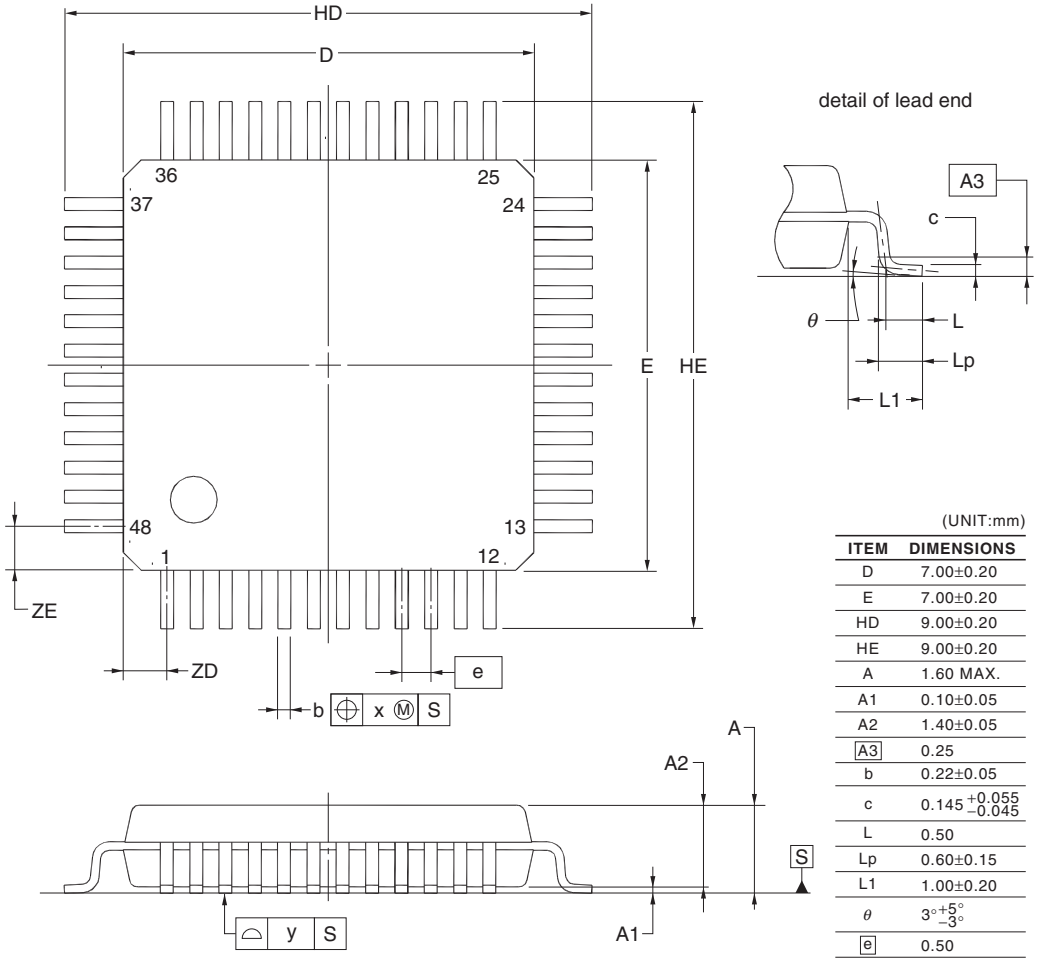
**Caution Select the TTL input buffer and the N-ch open drain output ($V_{DD}$ tolerance (for the 20- to 52-pin products)/$EV_{DD}$ tolerance (for the 64- to 100-pin products)) mode for the SDAr pin and the N-ch open drain output ($V_{DD}$ tolerance (for the 20- to 52-pin products)/$EV_{DD}$ tolerance (for the 64- to 100-pin products)) mode for the SCLr pin by using port input mode register g (PIMg) and port output mode register g (POMg). For $V_{IH}$ and $V_{IL}$, see the DC characteristics with TTL input buffer selected.**

(**Remarks** are listed on the next page.)

## 4.9 48-pin Products

R5F100GAAFB, R5F100GCAFB, R5F100GDAFB, R5F100GEAFB, R5F100GFAFB, R5F100GGAFB, R5F100GHAFB, R5F100GJAFB, R5F100GKAFB, R5F100GLAFB
R5F101GAAFB, R5F101GCAFB, R5F101GDAFB, R5F101GEAFB, R5F101GFAFB, R5F101GGAFB, R5F101GHAFB, R5F101GJAFB, R5F101GKAFB, R5F101GLAFB
R5F100GADFB, R5F100GCDFB, R5F100GDDFB, R5F100GEDFB, R5F100GFDFB, R5F100GGDFB, R5F100GHDFB, R5F100GJDFB, R5F100GKDFB, R5F100GLDFB
R5F101GADFB, R5F101GCDFB, R5F101GDDFB, R5F101GEDFB, R5F101GFDFB, R5F101GGDFB, R5F101GHDFB, R5F101GJDFB, R5F101GKDFB, R5F101GLDFB
R5F100GAGFB, R5F100GCGFB, R5F100GDGFB, R5F100GEGFB, R5F100GFGFB, R5F100GGGFB, R5F100GHGFB, R5F100GJGFB

| JEITA Package Code | RENESAS Code | Previous Code | MASS (TYP.) [g] |
|---|---|---|---|
| P-LFQFP48-7x7-0.50 | PLQP0048KF-A | P48GA-50-8EU-1 | 0.16 |




(UNIT:mm)

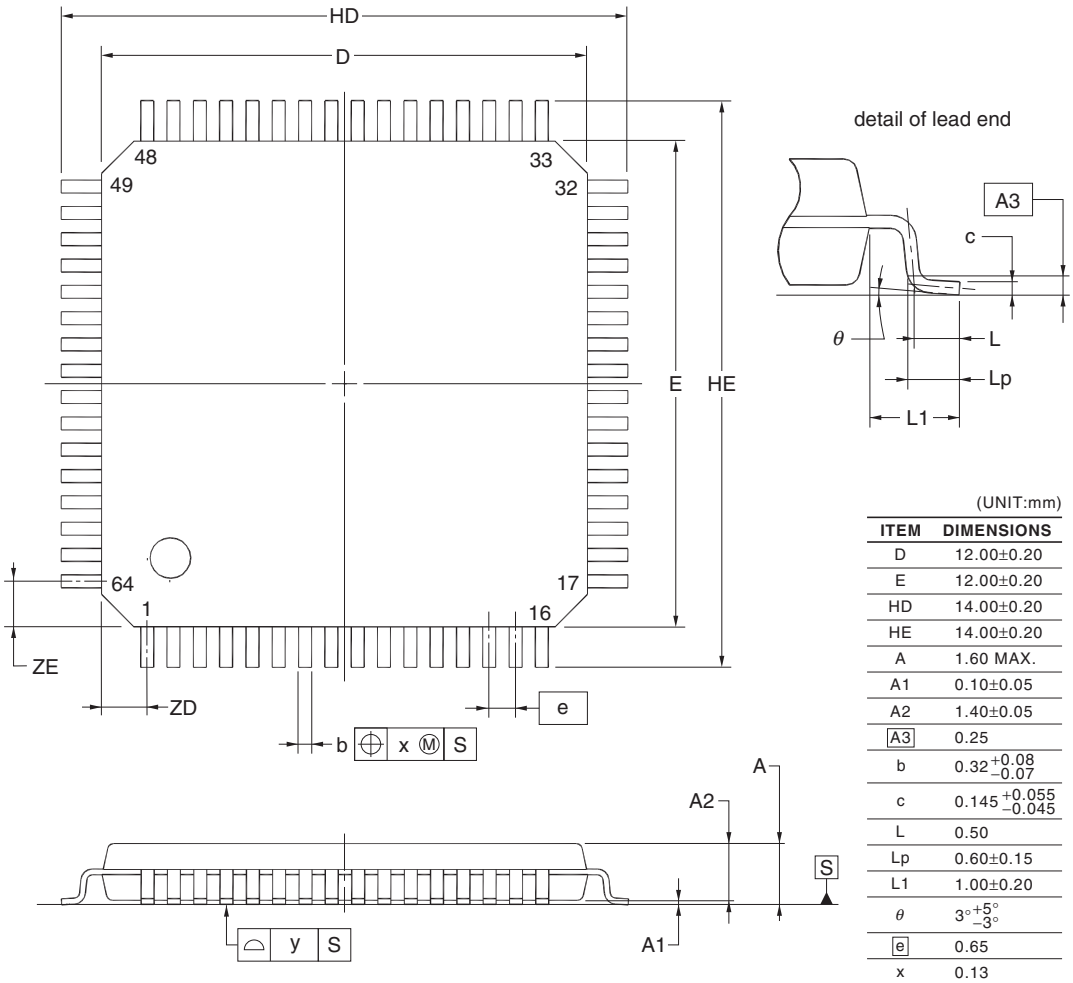
| ITEM | DIMENSIONS |
|---|---|
| D | 7.00±0.20 |
| E | 7.00±0.20 |
| HD | 9.00±0.20 |
| HE | 9.00±0.20 |
| A | 1.60 MAX. |
| A1 | 0.10±0.05 |
| A2 | 1.40±0.05 |
| A3 | 0.25 |
| b | 0.22±0.05 |
| c | $0.145^{+0.055}_{-0.045}$ |
| L | 0.50 |
| Lp | 0.60±0.15 |
| L1 | 1.00±0.20 |
| θ | $3^{\circ}{}^{+5^{\circ}}_{-3^{\circ}}$ |
| e | 0.50 |
| x | 0.08 |
| y | 0.08 |
| ZD | 0.75 |
| ZE | 0.75 |

**NOTE**
Each lead centerline is located within 0.08 mm of its true position at maximum material condition.

## 4.11 64-pin Products

R5F100LCAFA, R5F100LDAFA, R5F100LEAFA, R5F100LFAFA, R5F100LGAFA, R5F100LHAFA, R5F100LJAFA, R5F100LKAFA, R5F100LLAFA
R5F101LCAFA, R5F101LDAFA, R5F101LEAFA, R5F101LFAFA, R5F101LGAFA, R5F101LHAFA, R5F101LJAFA, R5F101LKAFA, R5F101LLAFA
R5F100LCDFA, R5F100LDDFA, R5F100LEDFA, R5F100LFDFA, R5F100LGDFA, R5F100LHDFA, R5F100LJDFA, R5F100LKDFA, R5F100LLDFA
R5F101LCDFA, R5F101LDDFA, R5F101LEDFA, R5F101LFDFA, R5F101LGDFA, R5F101LHDFA, R5F101LJDFA, R5F101LKDFA, R5F101LLDFA
R5F100LCGFA, R5F100LDGFA, R5F100LEGFA, R5F100LFGFA, R5F100LGGFA, R5F100LHGFA, R5F100LJGFA

| JEITA Package Code | RENESAS Code | Previous Code | MASS (TYP.) [g] |
|---|---|---|---|
| P-LQFP64-12x12-0.65 | PLQP0064JA-A | P64GK-65-UET-2 | 0.51 |




(UNIT:mm)

| ITEM | DIMENSIONS |
|---|---|
| D | 12.00±0.20 |
| E | 12.00±0.20 |
| HD | 14.00±0.20 |
| HE | 14.00±0.20 |
| A | 1.60 MAX. |
| A1 | 0.10±0.05 |
| A2 | 1.40±0.05 |
| A3 | 0.25 |
| b | $0.32^{+0.08}_{-0.07}$ |
| c | $0.145^{+0.055}_{-0.045}$ |
| L | 0.50 |
| Lp | 0.60±0.15 |
| L1 | 1.00±0.20 |
| θ | $3^{\circ}{}^{+5^{\circ}}_{-3^{\circ}}$ |
| e | 0.65 |
| x | 0.13 |
| y | 0.10 |
| ZD | 1.125 |
| ZE | 1.125 |

**NOTE**
Each lead centerline is located within 0.13 mm of its true position at maximum material condition.